03/16/2017 504275485

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4322167

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHANG-YIN CHEN	09/16/2014
TUNG-WEN CHENG	09/16/2014
CHE-CHENG CHANG	09/16/2014
JR-JUNG LIN	09/16/2014
CHIH-HAN LIN	09/16/2014

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.	
Street Address:	NO. 8, LI-HSIN RD. 6	
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK	
City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	300	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15460771

CORRESPONDENCE DATA

Fax Number: (202)756-8087

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 202-756-8000

Email: ipdocketmwe@mwe.com

MCDERMOTT WILL & EMERY LLP **Correspondent Name:** Address Line 1: THE MCDERMOTT BUILDING

Address Line 2: 500 NORTH CAPITOL STREET, N.W.

Address Line 4: WASHINGTON, D.C. 20001

ATTORNEY DOCKET NUMBER:	050094-0235	
NAME OF SUBMITTER:	STEPHEN A. BECKER	
SIGNATURE:	/STEPHEN A. BECKER/	
DATE SIGNED:	03/16/2017	

PATENT REEL: 041598 FRAME: 0035 504275485

Total Attachments: 2

source=EXECUTEDASSIGNMENT#page1.tif source=EXECUTEDASSIGNMENT#page2.tif

PATENT REEL: 041598 FRAME: 0036 NP-15370-US-B1 TSMC2014-0684

Inventor(s)-to-Assignee

ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title)				
APPARATUS AND METHOD OF MANUFACTURING FIN-FET DEVICES				
The PATENT RIGHTS referred to in this agreement are:				
(check one) a patent application for this invention, executed by the ASSIGNOR(S)				
concurrently with this assignment.				
XU.S. patent application Serial No. 14/502,784, filed on September 30, 2014				
a U.S. patent application based on PCT International Application				
Nofiled on (date)(U.S. patent application				
Serial No, if known).				
U.S. patent No, issued				
The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of				
the patents and patent applications identified above.				
The PATENT RIGHTS assigned under this agreement are:				
(check one) 🖂 U.S. patent rights only.				
Worldwide patent rights. In this case, the assignee shall have the right to				
claim the benefit of the filing date of any U.S. or foreign patent application				
for this invention.				
The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures				
appear on page 2 of this Assignment and any Supplemental Sheet(s).				
The ASSIGNEE referred to in this agreement is:				
(Name of Assignee) TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.				
(Address) NO.8. LI-HSIN RD.6, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU,				
TAIWAN 300, R.O.C.				
The ASSIGNEE is:				
(check one) An individual.				
☐A Partnership.				
A Corporation of <u>TAIWAN, R.O.C.</u> (specify state or country)				
(other)				

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;

the entire right, title and interest in and to the PATENT RIGHTS;

the right to sue and recover for any past infringement; and

the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

PATENT REEL: 041598 FRAME: 0037 NP-15370-US-B1 TSMC2014-0684

jychenej 2014-09-16 14:38:53

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO ASSIGNEE: TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. INVENTION TITLE: APPARATUS AND METHOD OF MANUFACTURING FIN-FET DEVICES

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

Chang-Yin CHEN	Chang In Ohen	2014.09.16
Name of sole or first inventor	Signature 7	Date
Tung-Wen CHENG	Tung-Wen Ohe Signature	ng >014,09, 16
Name of second inventor, if any	Signature	// Date
Che-Cheng CHANG	Chs-Chery Chan Signature	y 2014 19/16
Name of third inventor, if any	Signature	∤ Date
Jr-Jung LIN	Jr Jany L'a Signature	Date > 14/9/16
Name of fourth inventor, if any	Signature O	Date
Chih-Han LIN	Charles Con	- rry 12
Name of fifth inventor, if any	Signature	Date

PATENT REEL: 041598 FRAME: 0038

RECORDED: 03/16/2017